Docket No. <u>112857-490</u>

Form PTO-1595 (Rev. 03/01) OMB No. 0651-0027 (exp. 5/31/2002) RECORDATION FO PATENT	'S ONLY				
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.					
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):				
(1) Osamu Watanabe	Name: Sony Corporation				
(2) Tetsugo Inada					
(3) Hideshi Yamada	Internal Address:				
(4) Yasuhiro Monyama					
Additional name(s) of conveying party(ies) attached? Yes X No					
3. Nature of conveyance:	Sanita II - Gae was				
x Assignment _ Merger	Street Address: 7-35, Kitashinagawa 6-chome				
_ Security Agreement _ Change of Name	Shinagawa-ku				
_ Other	City: Tokyo State: Zip:				
_ \	Country: Japan				
Execution Date(s): (1)(3) 09-07-05; (2) 09-22-05;	Additional name(s) & address(es) attached? Yes X No				
(4) 09-08-05					
4. Application number(s) or patent number(s):					
If this document is being filed together with a new applica	tion, the execution date of the application is:				
A. Patent Application No.(s) 10/550,195 Additional numbers at	B. Patent No.(s) tached? ☐ Yes [x] No				
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: 1				
concerning document should be mailed:	7. Total fee (37 CFR 3.41)\$40.00				
Thomas C. Basso	Enclosed				
Bell, Boyd & Lloyd LLC	'x Authorized to be charged to deposit account				
P.O. Box 1135 Chicago, Illinois 60690-1135	8. Deposit account number:				
Fax: 312.827.8185	02-1818				
DO MOTE LIGH	(Attach duplicate copy of this page if paying by deposit account)				
· · · · · · · · · · · · · · · · · · ·	THIS SPACE				
9. Statement and signature.	information in topo and correct and any attached comiting				
true copy of the original document.	information is true and correct and any attached copy is a				
Thomas C. Basso (46,541)	January 20, 2006				
Name of Person Signing	Signature Date				
Total number of pages including cover sheet, attachments, and documents: 3					

Mail documents to be recorded with required cover sheet information to: Commissioner for Patents, Mail Stop Assignments, P.O. Box 1450, Alexandria, VA 22313-1450

S04P0701US00

Docket Number: 112875-490

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DEVICE CONTROL PROCESSING APPARATUS AND METHOD, DISPLAY PROCESSING APPARATUS AND METHOD.

AND COMPUTER PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents. Designs and Industrial Models, and any other international agreements to which the United States of America. adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: International Application No.: PCT/JP04/006613 ___, International Filing Date: May 11, 2004

This assignment executed on the dates indicated below.

Osamu WATANABE

Name of first or sole inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of first or sole inventor Osamu Watanabe

September 7, 2005

Signature of first or sole inventor

Date of this assignment

PATENT **REEL: 017204 FRAME: 0823**

S04P0701US00

Tetsugo INADA					
Name of second inventor			Francis J	-1 0110	
Tokyo, Japan			тухеспілов п	ate of U.S. Pa	itent Application
Residence of second inventor			<u> </u>		·
Jetsugne Ina	da	Septem	ber 22,	2005	
Signature of second inventor					this assignment
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			•		
Hida-hi seessa					
Hideshi YAMADA			•		
Name of third inventor			Execution da	te of U.S. Pa	tent Application
Tokyo, Japan				•	
Residence of third inventor			<u> </u>	<u> </u>	· · · · · · · · · · · · · · · · · · ·
Hideshi Yamada		September	7,2005)
Signature of third inventor	<u> </u>				this assignment
					•
Yasuhiro MORIYAMA					
Name of fourth inventor			Execution da	te of U.S. Pa	tent Application
Tokyo, Japan		# :			
Residence of fourth inventor					·
Yasahira Moriya	ma	September	8,200	5	
Signature of fourth inventor				Date of	this assignment
		•			
Name of fifth inventor			Execution da	ate of U.S. Pa	tent Application
•					
Residence of fifth inventor	,				
Signature of fifth inventor				Date o	f this assignment

PATENT REEL: 017204 FRAME: 0824

RECORDED: 01/20/2006